## **REMARKS**

The foregoing claims 16-23 are all supported by the embodiment of FIGS. 10-16. Claims 16-18 are also supported by the embodiment of FIGS. 1-9.

The embodiment of FIGS. 10-16 was first presented in a parent continuation-in-part application, Serial No. 08/100,494, filed on August 2, 1993. In June, 1992, more than one year before the effective filing date of the embodiment of FIGS. 10-16 herein, the product shown in the applicant's earlier parent Patent No. 5,345,170 (corresponding to FIGS. 1-9 hereof) was offered for sale. Therefore, the product shown in the '170 patent should be considered as prior art with respect to claims 19-23, because these claims are supported only by FIGS. 10-16. However, the device shown in the '170 patent lacks any structure comparable to the conductive component 295 described in element (e) of claims 19-23, and therefore does not affect the patentability of these claims. (The product shown in the '170 patent is not prior art with respect to claims 16-18, because these latter claims are supported by FIGS. 1-9 as well as FIGS. 10-16.)

Attached hereto is a marked-up version of the changes made to the specification by the current amendment.

Respectfully submitted,

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